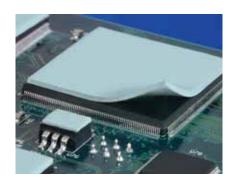
Gap Pad® 5000S35

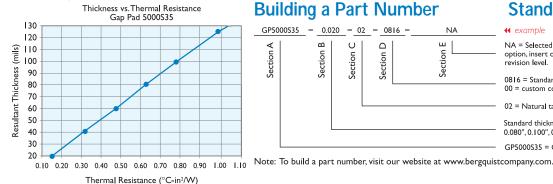
High thermal conductivity plus "S-Class" softness and conformability

Features and Benefits

- High thermal conductivity: 5 W/m-K
- Highly conformable, "S-Class" softness
- Natural inherent tack reduces interfacial thermal resistance
- Conforms to demanding contours and maintains structural integrity with little or no stress applied to fragile component leads
- Fiberglass reinforced for puncture, shear and tear resistance
- Excellent thermal performance at low pressures



Gap Pad 5000S35 is a fiberglass-reinforced filler and polymer featuring a high thermal conductivity. The material yields extremely soft characteristics while maintaining elasticity and conformability. The fiberglass reinforcement provides easy handling and converting, added electrical isolation and tear resistance. The inherent natural tack on both sides assists in application and allows the product to effectively fill air gaps, enhancing the overall thermal performance. The top side has reduced tack for ease of handling. Gap Pad 5000S35 is ideal for high-performance applications at low mounting pressures.



TYPICAL PROPERTIES OF GAP PAD 5000S35 PROPERTY IMPERIAL VALUE METRIC VALUE TEST METHOD Color Light Green Light Green Visual Reinforcement Carrier Fiberglass Fiberglass Thickness (inch) / (mm) 0.020 to 0.125 0.508 to 3.175 ASTM D374 Inherent Surface Tack (1 or 2 sided) 2 Density (q/cc) 3.6 ASTM D792 36 Heat Capacity (J/g-K) 1.0 1.0 ASTM E1269 Hardness Bulk Rubber (Shore 00) (1) 35 35 ASTM D2240 Young's Modulus (psi) / (kPa) (2) 17.5 121 ASTM D575 Continuous Use Temp (°F) / (°C) -76 to 392 -60 to 200 **ELECTRICAL** Dielectric Breakdown Voltage (Vac) >5000 >5000 ASTM D149 Dielectric Constant (1000 Hz) 7.5 7.5 ASTM D150 Volume Resistivity (Ohm-meter) 109 109 ASTM D257 Flame Rating V-O V-O U.L. 94 **THERMAL** Thermal Conductivity (W/m-K) ASTM D5470 50 THERMAL PERFORMANCE vs. PRESSURE Pressure (psi) 50 1.10 TO-220 Thermal Performance (°C/W) (20 mil) 0.99 1.18 Thermal Impedance (°C-in²/W) (3) 0.21 0.18 0.15 TO-220 Thermal Performance (°C/W) (40 mil) 1.54 1.34 1.15 Thermal Impedance (°C-in²/W) (3) 0.30 0.28 0.25

1) Thirty second delay value Shore 00 hardness scale. 2) Young's Modulus, calculated using 0.01 in/min. step rate of strain with a sample size of 0.79 inch². For more information on Gap Pad modulus, refer to Bergquist Application Note #116. 3) The ASTM D5470 test fixture was used. The recorded value includes interfacial thermal resistance. These values are provided for reference only. Actual application performance is directly related to the surface roughness, flatness and pressure applied

Typical Applications

- CDROM / DVD ROM
- Voltage Regulator Modules (VRMs) and POLs
- Thermally-enhanced BGAs

- Memory packages / modules
- PC Board to chassis
- ASICs and DSPs

Configurations Available:

- Die-cut parts are available in any shape or size, separated or in sheet form
- · Custom thicknesses available upon request

Building a Part Number

Section D Section A Section

Standard Options

NA = Selected standard option. If not selecting a standard option, insert company name, drawing number, and revision level

0816 = Standard sheet size 8" x 16", or 00 = custom configuration

02 = Natural tack, both sides

Standard thicknesses available: 0.020", 0.040", 0.060" 0.080", 0.100", 0.125"

GP5000S35 = Gap Pad 5000S35 Material

Gap Pad®: U.S. Patent 5,679,457 and others

EEROUST

www.bergquistcompany.com

The Bergquist Company -North American Headquarters 18930 West 78th Street Chanhassen, MN 55317 Phone: 800-347-4572 Fax: 952-835-0430

The Bergquist Company European Headquarters Bramenberg 9a, 3755 BT Eemnes Netherlands Phone: 31-35-5380684 Fax: 31-35-5380295

The Bergquist Company - Asia No. 38-40, Au Pui Wan Street Fotan, Shatin, N.T. Hong Kong Ph: 852 2690.294 Fax: 852.2690.2344 All statements, technical information and recommendations herein are based on tests we believe to be reliable, and THE FOLLOWING IS MADE IN LIEU OF ALL WARRANTIES, EXPRESSED OR IMPLIED, INCLUDING THE IMPLIED WARRANTIES OF MARKETABILITY AND FITNESS FOR PURPOSE. Sellers' and manufacturers' only obligation shall be to replace such quantity of the product proved to be defective. Before using user shall determine the suitability of the product for its intended use, and the user assumes all risks and liability whatsoever in connection therewith. NETHER SELLER NOR MANUFACTURER SHALL BE LIABLE EITHER INTORT OR IN CONTRACT FOR ANY LOSS OR DAMAGE, DIRECT, INCIDENTAL, OR CONSEQUENTIAL, INCLUDING LOSS OF PROFITS OR REVENUE ARSING OUT OF THE USE OR THE INABILITYTO USE A PRODUCT. No statement, purchase order or recommendations by seller or purchaser not contained herein shall have any force or effect unless in an agreement signed by the officers of the seller and manufacturer.

PDS. GP. 5000S35, 12.08 PDS_GP_5000S35_12.08